	12-06-2	Docket No.:501.40459X00
FORM PTO-6395 1-31-92	RE	HEET U.S. DEPARTMENT OF COMMERC Patent and Trademurk Office 1 3 0 1
To the Honorable Commissioner of	101908	380
1. Name of conveying party (S): Kimio TATSUNO Hiroaki FURUICHI Kazumi KAWAMOTO Katsumi KUROGUCHI Additional name(s) of conveying party(ies)	at a	Name and address of receiving party(ies): Name: Hitachi, Ltd. Street Address: 6, Kanda Surugadai 4-chome, Chiyoda-ku
3. Nature of conveyance: Assignment		City: Tokyo: Country: Japan Additional name(s) & address(es) attached? Yes No
4. Application number(s) or patent r	number(s):	
**	ether with a new application, t	the execution date of the application is: B. Patent No.(s)
	Additional numbers atta	ched? Yes X No
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1
Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Internal Address:		7. Total fee (37 CFR 3.41)\$40.00 Enclosed Any deficiencies may be charged to deposit account Authorized to be charged to deposit account
Street Address: 1300 North Seventeenth Street Suite 1800 City Arlington State: VA Zip: 22209		8. Deposit account number: 01-2135 (Attach duplicate copy of this page if paying by deposit account)
City: Arlington State: VA		E THIS SPACE
9. Statement and signature. To the best of my knowled of the original document. Melvin Kraus Name of Person Signing Attorney Registration No. 22, 466 Total number of pages including cover sheet	Maly Mary Signature	formation is true and correct and any attached copy is a true copy December 3, 2001 Date

PATENT REEL: 012334 FRAME: 0528

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

RECORDED: 12/03/2001

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

LASER DIODE MODULE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside our signatures:

!NVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) /himotaten	10/24/2001
2) Miroad i Ferrick	11/1/2001
3) Kazuni Kawamato	11/6/2011
4) Katsuni Kurogudii	10/30/2001
5)	
6)	
7)	
8)	
9)	
10)	

PATENT REEL: 012334 FRAME: 0529